

LCD and Camera EMI Filter Array with ESD Protection

Features

- Six or eight channels of EMI filtering with integrated ESD protection
- Pi-style EMI filters in a capacitor-resistor-capacitor (C-R-C) network
- ±15kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- ±30kV ESD protection on each channel (HBM)
- Greater than -35dB attenuation (typical) at 1 GHz
- TDFN package with 0.50mm lead pitch:
 - 6-ch. = 12-lead TDFN
 - 8-ch. = 16-lead TDFN
- Tiny TDFN package size:
 - 12-lead: 3.0mm x 1.35mm
 - 16-lead: 4.0mm x 1.60mm
- Increased robustness against vertical impacts during manufacturing process
- Lead-free finishing

Applications

- LCD and Camera data lines in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- Wireless handsets
- Handheld PCs/PDAs
- LCD and camera modules

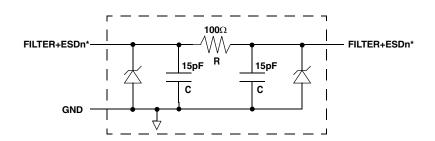
Product Description

The CM1409 is a family of pi-style EMI filter arrays with ESD protection, which integrates either six or eight filters (C-R-C) in a small form factor, TDFN 0.50mm pitch package. The CM1409 has component values of 15pF- 100Ω -15pF per channel. The CM1409 has a cut-off frequency of 110MHz and can be used in applications with data rates up to 44Mbps. The parts include ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components against electrostatic discharge (ESD). The ESD protected diodes safely dissipate ESD strikes of ±15kV, which even exceeds the maximum requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30kV.

These devices are particularly well-suited for portable electronics (e.g. wireless handsets, PDAs, notebook computers) because of their small package and easy-to-use pin assignments. In particular, the CM1409 is ideal for EMI filtering and protecting data and control lines for the I/O data ports, LCD display and camera interface in mobile handsets.

The CM1409 is housed in space-saving, low-profile 12and 16-lead TDFN packages with a 0.50mm pitch, lead-free finishing.

Electrical Schematic



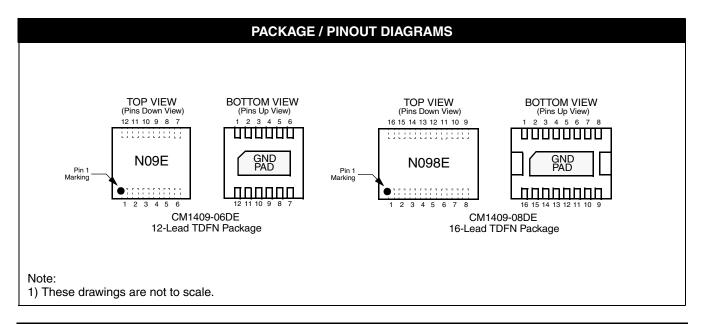
1 of 6 or 8 EMI/RFI + ESD Channels

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* See Package/Pinout Diagram for expanded pin information.

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	PIN DESCRIPTIONS									
DEVICE PIN(s)					VICE N(s)					
-06	-08	NAME	DESCRIPTION	-06	-08	NAME	DESCRIPTION			
1	1 1 FILTER1 Filter + ESD C		Filter + ESD Channel 1	12	16	FILTER1	Filter + ESD Channel 1			
2	2 2 FILTER2		Filter + ESD Channel 2	11	15	FILTER2	Filter + ESD Channel 2			
3	3	FILTER3	Filter + ESD Channel 3	10	14	FILTER3	Filter + ESD Channel 3			
4 4 F		FILTER4	Filter + ESD Channel 4	9	13	FILTER4	Filter + ESD Channel 4			
5 5		FILTER5	Filter + ESD Channel 5	8	12	FILTER5	Filter + ESD Channel 5			
6	6	FILTER6	Filter + ESD Channel 6	7	11	FILTER6	Filter + ESD Channel 6			
7		FILTER7	Filter + ESD Channel 7		10	FILTER7	Filter + ESD Channel 7			
8		FILTER8	Filter + ESD Channel 8		9	FILTER8	Filter + ESD Channel 8			
GNE	PAD	GND	Device Ground							

Ordering Information

PART NUMBERING INFORMATION							
Pins Package Lead-free Finish							
		Ordering Part Number ¹	Part Marking				
12	TDFN-12	CM1409-06DE	N09E				
16	TDFN-16	CM1409-08DE	N098E				

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.



Specifications

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	RATING	UNITS				
Storage Temperature Range	-65 to +150	°C				
DC Power per Resistor	100	mW				
DC Package Power Rating	500	mW				

STANDARD OPERATING CONDITIONS						
PARAMETER	RATING	UNITS				
Operating Temperature Range	-40 to +85	°C				

	ELECTRICAL OPE	RATING CHARACTERIST	ICS (S	EE NOT	E1)	
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
R	Resistance		80	100	120	Ω
C _{TOTAL}	Total Channel Capacitance	At 2.5VDC Reverse Bias, 1MHz, 30mVAC	24	30	36	pF
С	Capacitance C ₁	At 2.5VDC Reverse Bias, 1MHz, 30mVAC		15		pF
V _{DIODE}	Standoff Voltage	I _{DIODE} =10μA		6.0		V
I _{LEAK}	Diode Leakage Current (reverse bias)	V _{DIODE} =+3.3V		0.1	1.0	μΑ
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10mA I _{LOAD} = -10mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4- 2 Level 4	Notes 2 and 3	±30 ±15			kV kV
R _{DYN}	Dynamic Resistance Positive Negative			2.3 0.9		Ω
f _C	Cut-off Frequency Z_{SOURCE} =50 Ω , Z_{LOAD} =50 Ω	Channel R = 100Ω , Channel C = $15pF$		110		MHz
A _{1GHz}	Absolute Attenuation @ 1GHz from 0dB Level	$Z_{SOURCE} = 50\Omega$, $Z_{LOAD} = 50\Omega$, DC Bias = 0V; Notes 1, 4 and 5		35		dB
A _{800MHz} - 6GHz	Absolute Attenuation @ 800MHz to 6GHz from 0dB Level	$Z_{SOURCE} = 50\Omega$, $Z_{LOAD} = 50\Omega$, DC Bias = 0V; Notes 1, 4 and 5		30		dB

Note 1: $T_A=25$ °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: These parameters are guaranteed by design and characterization.

Note 4: Attenuation / RF curves characterized by a network analyzer using microprobes.

Note 5: These parameters are NOT guaranteed by design, characterization and production.

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Performance Information

Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)

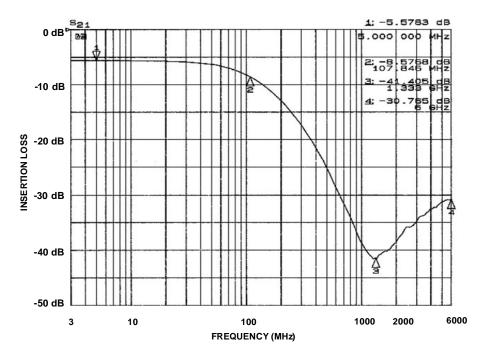


Figure 1. Insertion Loss vs. Frequency (FILTER1 Input to GND)

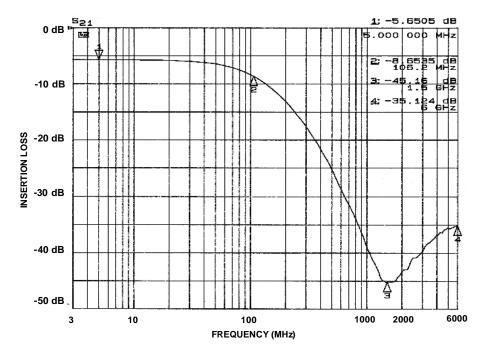


Figure 2. Insertion Loss vs. Frequency (FILTER2 Input to GND)

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Performance Information (cont'd)

Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)

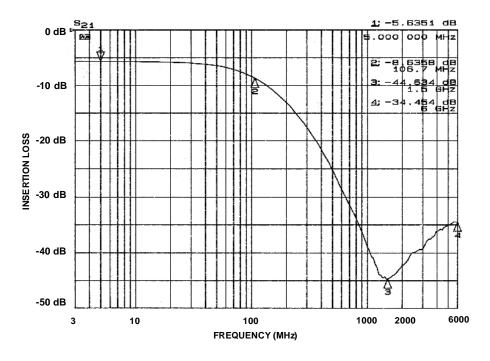


Figure 3. Insertion Loss vs. Frequency (FILTER3 Input to GND)

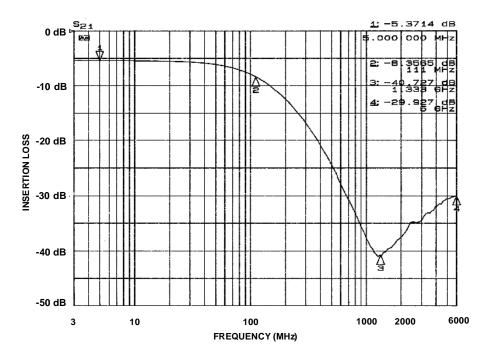


Figure 4. Insertion Loss vs. Frequency (FILTER4 Input to GND)

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Performance Information (cont'd)

Typical Diode Capacitance vs. Input Voltage

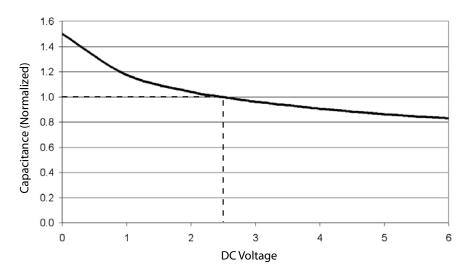


Figure 5. Filter Capacitance vs. Input Voltage (normalized to capacitance at 2.5VDC and 25°C)

490 N. McCarthy Blvd., Milpitas, CA 95035-5112



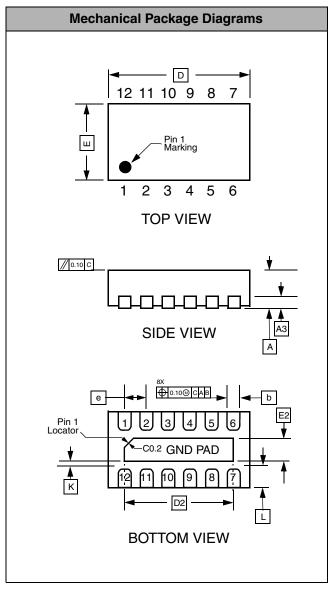
Mechanical Details

TDFN-12 Mechanical Specifications

The CM1409-06DE is supplied in a 12-lead, 0.5mm pitch TDFN package. Dimensions are presented below.

PACKAGE DIMENSIONS									
Package		TDFN							
JEDEC No.			MO-2	229C [†]					
Leads			1	12					
Dim.	N	lillimete	rs		Inches				
Dilli.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
А3	0.20 REF 0.008 REF					F			
b	0.20	0.25	0.30	0.008	0.010	0.012			
D	2.90	3.00	3.10	0.114	0.118	0.122			
D2	2.40	2.50	2.60	0.095	0.098	0.102			
E	1.25	1.35	1.45	0.049	0.053	0.057			
E2	0.35	0.40	0.45	0.014	0.016	0.018			
е		0.50 BS	C	0	.020 BS	С			
K	0.20			0.008					
L	0.20	0.25	0.30	0.008	0.010	0.012			
# per tape and reel	3000 pieces								
	Controlling dimension: millimeters								

[†]This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.



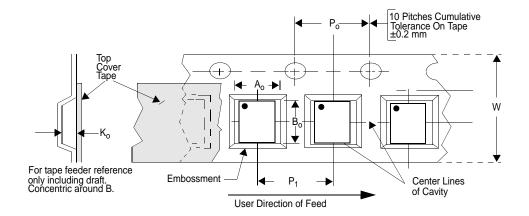
Dimensions for 12-Lead, 0.5mm pitch TDFN package

Fax: 408.263.7846



Tape and Reel Specifications

PART NUMBER	PACKAGE SIZE (mm)	POCKET SIZE (mm) B ₀ X A ₀ X K ₀	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P ₀	P ₁
CM1409-06DE	3.00 X 1.35 X 0.75	3.30 X 1.65 X 1.05	8mm	178mm (7")	3000	4mm	4mm





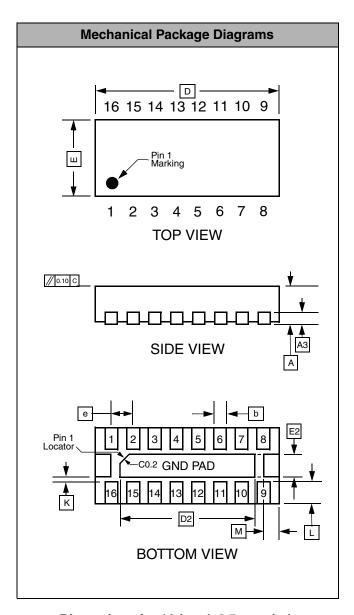
Mechanical Details (cont'd)

TDFN-16 Mechanical Specifications

The CM1409-08DE is supplied in a 16-lead, 0.5mm pitch TDFN package. Dimensions are presented below.

	PACI	KAGE	DIME	NSIOI	NS				
Package		TDFN							
JEDEC No.			MO-2	229C [†]					
Leads			1	16					
Dim.	N	lillimete	rs		Inches				
Dilli.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
А3	(0.20 RE	F	C	.008 RE	F			
b	0.20	0.25	0.30	0.008	0.010	0.012			
D	3.90	4.00	4.10	0.153	0.157	0.161			
D2	3.10	3.20	3.30	0.122	0.126	0.130			
E	1.50	1.60	1.70	0.059	0.063	0.067			
E2	0.30	0.40	0.50	0.012	0.016	0.020			
е	(0.50 BS	0	().020 BS	SC SC			
K	0.20			0.008					
L	0.20	0.30	0.40	0.008	0.010	0.012			
М	0.25 REF 0.010 REF								
# per tape and reel		3000 pieces							
	Controlling dimension: millimeters								

[†]This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.



Dimensions for 16-Lead, 0.5mm pitch TDFN package

Cirtek POD-CEC-DFN16-013 4.00x1.60mm, 0.5mm pitch 16L TDFN



Tape and Reel Specifications

PART NUMBER	PACKAGE SIZE (mm)	POCKET SIZE (mm) B ₀ X A ₀ X K ₀	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P ₀	P ₁
CM1409-08DE	4.00 X 1.60 X 0.75	4.30 X 1.90 X 1.20	12mm	178mm (7")	3000	4mm	4mm

